Ge/ZnS-based micromachined Fabry-Perot filters for optical MEMS in the longwave infrared

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Abstract—This paper reports on the successful demonstration of Ge/ZnS-based Fabry-Perot filters operating in the longwave infrared (LWIR). The suitability of thermally deposited Ge and ZnS as thin film mirror materials for micromachined LWIR Fabry-Perot filters has been fully investigated, and it is shown that a film growth temperature higher than 150 °C is key to depositing durable ZnS films. The optical constants of Ge and ZnS films in the LWIR band reveal that the material pair possesses high refractive index contrast and excellent LWIR transparency. Fixed-cavity LWIR Fabry-Perot filters with a 150- μm circular single-layer Ge top mirror and a four-layer Ge/ZnS/Ge/ZnS bottom mirror were fabricated. Curvature in the suspended top mirror was corrected using a thin SiN_x stress-compensation layer. After curvature correction, a mirror flatness of 550 nm was achieved, and the filter demonstrated a 60 % peak transmission with a full-width at half-maximum of 700 nm as well as a out-of-band rejection of 24: 1.

Index Terms—Fabry-Perot, longwave infrared, LWIR, micro-machining, multispectral, optical filter, thermal imaging.

I. INTRODUCTION

LONGWAVE infrared (LWIR) multispectral imaging systems, capable of separating a completely passive thermal image into multiple spectral bands of interest within the 8–12 μm spectral range, not only enable better target identification but also can be used for material characterization and spectroscopy. As a field of increasing interest, LWIR multispectral imaging has been successfully deployed in various applications, including mineral mapping [1], [2], gas and volatile organic compound diagnostics [3]–[5], and water and land surface temperature monitoring [6], [7]. Conventional multispectral imagers employ mechanically-switched bulk filter systems to realize spectral selectivity. For example, based on the characteristic absorption of target analytes, Wabomba *et al.* [5] selected a set of LWIR bandpass filters with bandwidth of 0.5–1 μm , and integrated the filters in front of a detector array to produce wavelength-selective detection channels. This type of configuration, based on standard bulk optics, is typically characterized by significant size and cost, which prohibits their widespread use in many desirable applications. On the other hand, micro-electromechanical systems (MEMS) based Fabry-Perot tunable filters can be small and lightweight, and less costly to manufacture in comparison to their bulk filter counterparts.

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Fig. 1. 3D view of the MEMS-based shortwave infrared Fabry-Perot filter using Ge/SiO-based mirrors [13] developed by the Microelectronics Research Group at the University of Western Australia.

Whilst MEMS-based LWIR Fabry-Perot filters have been previously reported [8]–[12], the published works concentrate on achieving high spectral resolution by use of highly reflective multilayer Bragg mirrors. These reports include Teledyne [8] with 120 nm FWHM and InfraTec [9], [10] with 200 nm FWHM, using multilayer Ge/ZnS-based mirrors. Top mirror deformation, arising from stress mismatch between different mirror layers, complicates fabrication of these filters. Mirror curvature can degrade filter optical performance. Mirror stress gradients in these filters were balanced either by tailoring the layer stress conditions [8] or by using very thick, mechanically stiff carrier wafers [9], [10]. In comparison, VTT [11], [12] realized a filter with 110 nm FWHM based on Si/air/Si mirrors, which are not subject to film stress mismatch. However, this filter requires an undesirable high-temperature annealing process to control Si film stress to produce flat mirrors. The LWIR filter presented in this paper exploits a simple single-layer top mirror approach to address the stress mismatch issue, and uses an additional stress-compensation layer to control residual top mirror stress gradient.

Our research team has previously demonstrated a MEMS-based shortwave infrared (SWIR: 1.6 to 2.5 μm) tunable Fabry-Perot filter for multispectral imaging applications [13]. The filter, as illustrated in Fig. 1, uses SiN_x electrostatic beam actuators to move the suspended top mirror relative to a fixed bottom mirror, thus decreasing the mirror spacing and thereby allowing controllable tuning of the peak wavelength of the filter. Each mirror in the filter is a multilayer Bragg mirror structure composed of high-index-contrast and low-loss

TABLE I
PERFORMANCE REQUIREMENTS OF TUNABLE FILTERS FOR LWIR
MULTISPECTRAL IMAGING APPLICATIONS

Parameter	Value	Comment
Peak transmission	>50%	Optical throughput for high SNR
FWHM	0.5–1 μm	Wavelength discrimination
Out-of-band rejection	>10: 1	Wavelength discrimination

Ge/SiO pairs. For transition of this technology into the LWIR band, although Ge is an ideal high-index material, SiO is far too absorbing [14]. There exists a wide variety of LWIR low-index materials that could be considered as a replacement for the SiO layers, such as ZnS, ZnSe and BaF₂ [15]. Our choice of ZnS for the low-index medium to replace SiO has many advantages. Firstly, from a fabrication perspective, standard thermal evaporation can be used to deposit high quality thin films of both Ge and ZnS, and both films exhibit good adhesion [16], [17]. Secondly, from an optical perspective, the material pair offers high refractive index contrast that can achieve highly reflective mirrors with a small number of periods. Moreover, because the refractive index of ZnS is close to the square root of that of the silicon substrate, a quarter-wave ZnS layer can also serve as an adequate anti-reflection coating, thus negating the need of a third material.

In this paper, we report on the fabrication of durable Ge and ZnS thin films using thermal evaporation, and on a method to measure the optical constants of these films. Using Ge/ZnS as mirror materials, a fixed-cavity LWIR Fabry-Perot filter with single-layer top mirror has been designed and fabricated, demonstrating spectral characteristics that meet the optical requirements for LWIR multispectral imaging applications listed in Table I.

II. THIN FILM FABRICATION

Material durability of each thin film layer is a concern for both the filter fabrication process and the long-term stability and operation of the fabricated device. In order to successfully fabricate fully functional devices, the thin films need to withstand multiple exposures to both de-ionized (DI) water and the alkaline-based photoresist developer used in photolithography. High purity Ge (99.999 wt% purity) and ZnS (99.99 wt% purity) sources were used for thermal evaporation. The Ge and ZnS thin films were deposited by electron-beam evaporation and thermal evaporation, respectively. Whereas Ge films deposited at room temperature showed excellent durability under exposure to DI water and AZ400K developer, the ZnS films deposited at room temperature were found to delaminate immediately upon contact with these chemicals.

In this work, we have examined the effect of substrate heating during thin film deposition, on the adhesion of ZnS films to silicon and germanium. Silicon and germanium are the materials on which ZnS deposition takes place for bottom mirror formation (see section IV). Prior to deposition, the silicon and germanium substrates underwent a series of solvent washes followed by ultrasonic cleaning. ZnS layers of 1 μm thickness were deposited by thermal evaporation at

TABLE II
DURABILITY OF 1 μm THICK ZnS FILMS PREPARED AT DIFFERENT
SUBSTRATE DEPOSITION TEMPERATURES

Substrate temperature ($^{\circ}\text{C}$)	The time taken to observe any delamination	
	In DI water	In AZ400K
50	immediately	immediately
100	5 mins	2 mins
≥ 150	> 2 days	> 2 days

a deposition rate of 0.2 nm/s onto the substrates with the substrate temperature during deposition maintained at either 50 $^{\circ}\text{C}$, 100 $^{\circ}\text{C}$, 150 $^{\circ}\text{C}$, 200 $^{\circ}\text{C}$ or 300 $^{\circ}\text{C}$. To test the durability of these ZnS films, the samples were submerged in DI water and AZ400K developer, and the time taken to observe any evidence of delamination or cracking was recorded. The entire experimental procedure was repeated twice, and very similar results were obtained on both occasions. The results are shown in Table II.

As evident from Table II, the durability of ZnS films deposited at substrate temperatures higher than 150 $^{\circ}\text{C}$ is significantly improved in comparison to films deposited at room temperature. Such a dramatic improvement in the adhesion properties can be attributed to the higher surface mobility of adatoms during deposition at higher substrate temperatures, thereby improving the packing density and overall quality of the films [18], [19].

III. THIN FILM OPTICAL CHARACTERIZATION

In order to characterize our deposition system and to establish that the deposited films have appropriate LWIR properties, the optical constants of the Ge films deposited at room temperature and the ZnS films deposited at 150 $^{\circ}\text{C}$ were studied. Although a variety of methods have been devised for determining the optical constants of thin films, such as ellipsometry [20] and film reflectance/transmittance measurements [21], we have chosen to investigate approaches that are compatible with our existing measurement capabilities, which rely on transmission spectra alone. Swanepoel *et al.* [22] reported on the use of fringe patterns of the transmission spectrum to calculate the optical constants of thin films; however, the primary technical challenge that prevents us from adopting this approach is the requirement to deposit sufficiently thick films to produce a sufficient number of fringes in the LWIR band. In this paper, we have implemented an optical transmission matrix model [23] based iterative analysis of the transmission spectrum to derive the optical constants.

The optical transmission matrix model can be explained as follows. Consider a multilayer thin film stack on a lossless substrate, where an individual layer f has a thickness d_f , a refractive index n_f and an extinction coefficient k_f , and the substrate has refractive index n_s . In the optical transmission matrix model, each layer is assigned a characteristic matrix, M_f , described as

$$[M_f] = \begin{bmatrix} \cos \delta_f & (i/\eta_f) \sin \delta_f \\ i\eta_f \sin \delta_f & \cos \delta_f \end{bmatrix}, \quad (1)$$

Fig. 2. (a) Layered structures used for determination of optical constants. (b) Transmittance measured by FTIR (open data points) and the best fit to transmittance using an iterative procedure (solid lines).

where $\eta_f = \eta_0 (n_f - ik_f)$ and $\eta_0 = 2.65 \times 10^{-3} \Omega^{-1}$ are optical admittances of layer f and free space, respectively, and $\delta_f = 2\pi d_f (n_f - ik_f)/\lambda$ is the optical phase change in layer f . For light incident from air and propagating through N thin-film layers towards the substrate, the optical transmission T for the entire stack is calculated by first evaluating the quantities B and C as the matrix product,

$$\begin{bmatrix} B \\ C \end{bmatrix} = [M_1][M_2] \cdots [M_N] \begin{bmatrix} 1 \\ \eta_0 n_s \end{bmatrix}, \quad (2)$$

and then by

$$T = \frac{4\eta_0^2 n_s}{(\eta_0 B + C)(\eta_0 B + C)^*} = \frac{4\eta_0^2 n_s}{|\eta_0 B + C|^2}. \quad (3)$$

Equation 3 can be used not only to calculate the optical transmittance of a multilayer stack given all the layer parameters, but also to extract unknown parameters of the constituent layers given a known stack transmittance.

Two multilayer structures, as depicted in Fig. 2a, consisting of multiple layers of Ge/ZnS on the front side and a single

layer of ZnS on the backside of silicon substrates, were fabricated for the purpose of determining the optical constants of the thin film layers. The substrates used in these structures were LWIR transparent float-zone (FZ) silicon wafers, because conventional Czochralski (CZ) silicon wafers exhibit strong LWIR absorption due to excessive oxygen content [24]. Apart from the middle Ge layer that was either 1700 nm or 1300 nm thick, which forms the optical cavity of the Fabry-Perot filter, all other Ge and ZnS layers that form the top and bottom mirrors were 600 nm and 1100 nm thick, respectively. Using the transmission spectra of these multilayer structures, rather than those of single layers, allows the optical constants of Ge and ZnS to be extracted simultaneously. In addition, the designed structures are essentially bandpass filters, which allows the optical performance to be evaluated at the same time.

Transmittance spectra for these structures were measured by Fourier transform infrared spectroscopy (FTIR), and are shown in Fig. 2b. The multilayer structure with a 1700 nm thick Ge layer as the optical cavity exhibited a second-order peak transmittance of 80% at the peak wavelength of 8.25 μm and a full-width at half-maximum (FWHM) of 500 nm. In comparison, for the structure with 1300 nm thick Ge layer as the optical cavity, the first-order peak transmittance and the FWHM were measured to be 85% at the peak wavelength of 10.5 μm and 750 nm, respectively. The measured high peak transmittance indicates that both the Ge and ZnS thin films are highly transparent in the LWIR. To derive thin film optical constants, a least-squares approach was implemented to fit the optical transmission matrix model (i.e. Equation 3) to the measured transmittance data of the two proposed multilayer structures. During the fit, refractive indices and extinction coefficients of Ge and ZnS thin film layers were iteratively varied, and layer thicknesses were fixed. Since both Ge and ZnS exhibit low dispersion in the LWIR band [25], [26], it was also assumed that the refractive indices and extinction coefficients of the investigated materials are constant over the entire LWIR range. When a goodness of fit of 99.9% was achieved, the optical constants of the electron-beam evaporated Ge and thermally evaporated ZnS were determined. Each multilayer structure determined one set of optical constants. The optical constants obtained from multiple similar multilayer structures were in excellent agreement. Table III compares these extracted optical constants with other published data.

IV. FABRY-PEROT FILTER IMPLEMENTATION

A. Optical Design and Modelling

The primary challenge for successful development of a Fabry-Perot LWIR filter is integration of the free-standing suspended top multilayer Bragg mirror. Due to the long wavelength being considered, a three-layer Ge/ZnS/Ge mirror stack is relatively thick (approximately 2.4 μm), and any stress mismatch between the constituting layers would highly deform the mirror and, thereby, severely degrade filter performance. In order to minimize any mirror bowing caused by stress gradients, the LWIR Fabry-Perot filter in this paper is designed to have a top suspended mirror comprised of a single quarter-wavelength thick layer of Ge rather than a Ge/ZnS/Ge stack.

TABLE III
OPTICAL CONSTANTS OF Ge AND ZnS THIN FILMS AT A WAVELENGTH
OF 10 μm

Ge			
	This paper	Donovan [27]	Potter [25]
n	4.0	3.98	4.0
k	2×10^{-5}	0	0
ZnS			
	This paper	Hall [28]	Addamiano [26]
n	2.2	2.17	2.2
k	2×10^{-3}	1×10^{-3}	8×10^{-6}

The bottom mirror of the filter was a 4-layer Ge/ZnS/Ge/ZnS structure deposited on a FZ silicon substrate. The Ge and ZnS layers were designed to be of quarter-wave thickness at the design wavelength of 10 μm . Based on our experimental values of refractive indices ($n = 4.0$ for Ge and $n = 2.2$ for ZnS), the required thicknesses of the Ge and ZnS layers were determined to be 625 nm and 1136 nm, respectively. Because the refractive index of thermally evaporated ZnS ($n = 2.2$) is approximately the square root of that of the silicon substrate ($n = 3.4$), a quarter-wave ZnS layer was also deposited on the backside as an anti-reflection coating.

In the proposed asymmetric filter, since the top mirror has only a single quarter-wave optical layer and is less reflective than the bottom mirror, a relatively wide spectral bandwidth is expected because of the resulting lower cavity finesse. Calculated spectra with variable air cavity length, d , were modelled using Equation 3, and are shown in Fig. 3. The calculations indicate that the proposed filter is capable of achieving a spectral resolution of about 500 nm FWHM, and a peak transmittance of greater than 80% across the entire 8–12 μm LWIR band. The filter also features an out-of-band light transmission of 2%. Given the peak transmission is above 80%, the out-of-band rejection is therefore better than 40:1. These performance figures adequately fulfil the requirements of an optical filter for multispectral imaging applications introduced in Table I.

B. Fabrication

Prototype Fabry-Perot filters with a fixed air cavity gap were fabricated using surface micromachining. The filter structure and its cross-section are illustrated in Fig. 4a and Fig. 4b, respectively. First, a four-layer quarter-wave stack of Ge/ZnS/Ge/ZnS for the bottom mirror was deposited on a FZ silicon wafer, followed another quarter-wave ZnS layer on the backside of the substrate to serve as an anti-reflection coating. A 200 nm thick Au layer was then deposited using thermal evaporation and lift-off, as an optical shield to block stray light from leaking around the filter onto the detector to be located optically behind the filter. The opening in this Au layer defines the optical aperture of the filter, and is 20 μm laterally smaller than the mirror, to avoid unintended stray light due to misalignment errors. A sacrificial polyimide layer was then spin-coated on the sample, with a thickness of 5.6

Fig. 3. The modelled spectra of the LWIR Fabry-Perot filter proposed in this paper, with variable cavity length d .

μm . Patterning of the polyimide to create the four step-down support anchors to the substrate was accomplished by dry etching the polyimide in an O_2 plasma with the use of a thick photoresist mask. A 5-nm thick compressively stressed (~ 150 MPa) PECVD SiN_x layer was then deposited and selectively removed in a CF_4 plasma from everywhere except directly below the top mirror. This SiN_x layer plays a role in balancing the compressive stress gradients inherent in the top Ge mirror, thereby reducing mirror bowing. The SiN_x layer, at several nanometres thick, has a negligible effect on the optical performance of the filter. A 250-nm thick Ge layer was then deposited using lift-off to form part of the top mirror, the tethers and beams, and the structural support for the suspended top mirror. Another 375-nm Ge layer was lift-off deposited in the mirror area, which, combined with the previous 250-nm Ge layer, forms a complete quarter-wave top mirror. An array of 4 μm diameter holes were etched to perforate the top mirror using a CF_4 plasma in order to facilitate the structural release process via removal of the sacrificial polyimide layer in an O_2 plasma. These holes allow the mirror to be fully released within a relatively short time and, therefore, prevent cracks forming in the Ge top mirror due to overheating from over-exposure to the O_2 release plasma. Importantly, stray light transmitted through the etch holes was shielded by an array of circular Au micropatterns, deposited on the bottom mirror directly below the etch hole array. A scanning electron microscope (SEM) image giving the structural dimensions of the fabricated device is shown in Fig. 4c.

C. Filter Characterization

Mirror flatness characteristics of the fabricated filters have been studied using a noncontact optical profilometer. Fig. 5 shows line scans of the top mirror surface profiles taken from profilometry measurements for two fabricated filters, with and without a SiN_x stress-compensation layer. It is revealed that the top mirror of the filter without the SiN_x stress-compensation layer exhibited a large convex center-to-edge bowing of 1.5 μm . This bowing is caused by the relief of

Fig. 4. (a) Schematic view of the LWIR Fabry-Perot filter proposed in this paper, and (b) cross section view of the filter, and (c) top view scanning electron micrograph of the fabricated LWIR Fabry-Perot filter and its structural dimensions.

residual in-built compressive stress gradients in the suspended structure. By the use of a SiN_x stress-compensation layer, the mirror bowing became significantly less convex, with the center-to-edge amplitude reduced to 550 nm. It is also noted that the fabricated mirrors exhibited no noticeable tilt.

The optical transmittance of the fabricated Fabry-Perot filters was measured as a function of wavelength using FTIR, and is presented in Fig. 6. The optical model curves shown in Fig. 6 include the effects of mirror bowing as measured by profilometry. Table IV compares the measured spectral characteristics

Fig. 5. Measured top mirror surface profiles of the fabricated LWIR Fabry-Perot filters, using an optical profilometer.

Fig. 6. The measured transmission spectra (open data points) and the modelled transmission spectra (solid line) of the fabricated LWIR Fabry-Perot filters. The modelling includes the effects due to top mirror bowing.

with the design values, as well as with the optical requirements of LWIR filters for multispectral imaging applications. It can be clearly seen that transmission characteristics of the filter in the absence of SiN_x stress-compensation layer are severely degraded due to the large mirror bowing, showing a poor peak transmittance of 20%, a wide FWHM of 1.3 μm and a small out-of-band rejection of 8:1; all of which are far from fulfillment of the optical requirements for LWIR multispectral imaging applications. In comparison, the transmission curve of the filter with a SiN_x stress-compensation layer shifts to shorter wavelengths, exhibiting a higher peak transmittance of 60%, a narrower FWHM of 700 nm and a larger out-of-band rejection ratio of 24:1. Such a dramatic improvement in the transmission characteristics and the observed blueshift in the peak transmission wavelength can be attributed to the mirror bowing reduction and the accompanying decrease in mirror separation, respectively, as indicated in Fig. 5. It is evident that despite still showing some degree of performance degradation in comparison to the intended design parameters,

TABLE IV
COMPARISON BETWEEN THE ACHIEVED SPECTRAL CHARACTERISTICS,
THE DESIGNED VALUES, AND THE VALUES REQUIRED FOR FABRY-PEROT
FILTERS IN LWIR MULTISPECTRAL IMAGING APPLICATIONS.

Parameter	Required	Design	Achieved	
			w/o SiN _x	w/ SiN _x
Peak transmission	>50%	>80%	20%	60%
Spectral width	0.5–1 μm	500 nm	1.3 μm	700 nm
Out-of-band rejection	>10: 1	>40: 1	8: 1	24: 1

the fabricated filter prototype that employs a SiN_x stress-compensation layer sufficiently meets the optical requirements for LWIR multispectral imaging applications, provided that it is incorporated with an appropriate electrostatic actuation mechanism.

V. CONCLUSIONS

A micromachined LWIR tunable optical filter is essential for the future realization of low-cost and robust LWIR multispectral imaging systems. In this paper, we have proposed a LWIR filter technology that is based on a MEMS Fabry-Perot optical cavity that has previously been demonstrated in the shortwave infrared region [13]. The direct extension of this technology to LWIR wavelengths is problematic, because the SWIR low index mirror material SiO₂ is excessively absorbing in the LWIR. This paper has presented the preparation and LWIR characterization of electron-beam deposited Ge and thermally deposited ZnS thin films for mirror formation, as well as implementation of these components to realize a micromachined LWIR Fabry-Perot filter. It was shown that while durable Ge films could be deposited at room temperature, high quality ZnS films need to be deposited at substrate temperatures above 150 °C. An iterative least-squares approach was successfully applied to extract the optical constants of Ge and ZnS thin films in the LWIR band. The refractive indices of Ge and ZnS were determined to be 4.0 and 2.2, respectively, showing high index contrast. The extinction coefficients of Ge and ZnS were determined to be 2×10^{-5} and 2×10^{-3} , respectively, showing excellent optical transparency. The Ge/ZnS material system was then considered in a LWIR Fabry-Perot filter design. While the filter was predicted to have at least 80% peak transmittance, a FWHM spectral width of approximately 500 nm, and an out-of-band rejection better than 40: 1 across the entire 8–12 μm range, the fabricated prototype filter with the employment of a mirror-stress compensation layer achieved a peak transmittance of 60%, a bandwidth of 700 nm, and an out-of-band rejection of 24: 1. Bowing of the suspended top mirror due to insufficient compensation of stress gradients has been identified as the primary source of degradation of optical performance. Although the measured filter performance characteristics did not achieve the theoretically predicted performance, they adequately satisfy the system requirements for multispectral LWIR imaging. Overall, the results presented in this paper represent an excellent starting point for the realization of tunable LWIR Fabry-Perot filters which can be integrated optically ahead of a detector array to realize

LWIR multispectral imaging systems. However, it should be noted that these results only showed partial correction of mirror bowing, and peak performance has not yet been demonstrated. This result also implies that the specifications for LWIR multispectral imaging scenarios (Table I) will not so easily be achieved for larger diameter filters because of excessive mirror distortion. In order to fabricate filters that suit a wider application scope, a more compressive SiN_x stress-compensation layer, which allows for complete balance of mirror stress, is needed.

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